

Si7186DP

Vishay Siliconix

N-Channel 80 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | | |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^a | Q _g (Typ.) | | | | |
| 80 | 0.0125 at V _{GS} = 10 V | 32 ^g | 46 nC | | | | |

PowerPAK SO-8

6.15 mm 15 mm Bottom View

Ordering Information: Si7186DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

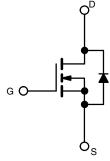
- TrenchFET[®] Power MOSFET
- 100 % Rg and UIS Tested
- Material categorization: definitions of For compliance www.vishay.com/doc?99912



COMPLIANT pleas HALOGEN FREE

APPLICATIONS

- **Primary Side Switch**
- POL
- Intermediate Bus Converter



N-Channel MOSFET

Unit

°C/W

| Parameter | Symbol | Limit | Unit | | |
|--|--|-----------------|--|---|--|
| Drain-Source Voltage | | V _{DS} | 80 | V | |
| Gate-Source Voltage | | V _{GS} | ± 20 | | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 25 °C T _C = 70 °C | I _D | 32 ⁹ 32 ⁹ | | |
| | T _A = 25 °C T _A = 70 °C | | 14.5 ^{b, c} 11.5 ^{b, c} | A | |
| Pulsed Drain Current | | I _{DM} | 60 | ~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~ | |
| Continuous Source-Drain Diode Current | T _C = 25 °C T _A = 25 °C | I _S | 32 ^g 4.5 ^{b, c} | | |
| Single Pulse Avalanche Current | | I _{AS} | 30 | | |
| Single Pulse Avalanche Energy L = 0.1 mH | | E _{AS} | 45 | mJ | |
| | T _C = 25 °C T _C = 70 °C | | 64 44 | | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 5.2 ^{b, c} | W | |
| | T _A = 70 °C | | 3.3 ^{b, c} | | |
| Operating Junction and Storage Temperature | Т _Ј , Т _{stg} | - 55 to 150 | °C | | |
| Soldering Recommendations (Peak Tempera | | 260 | | | |

THERMAL RESISTANCE RATINGS Parameter Symbol Typical Maximum $t \le 10 \text{ s}$ R_{thJA} Maximum Junction-to-Ambient^{b, f} 18 23 Maximum Junction-to-Case (Drain) Steady State 1.5 R_{thJC} 1

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

Maximum under steady state conditions is 65 °C/W. f.

g. Package limited.

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|--|-------------------------|---|------|--------|--------|-------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 80 | | | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | | | 90 | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | | - 11 | | mV/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 2.5 | | 4.5 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zere Cate Veltage Durin Comment | I _{DSS} | $V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | |
| Zero Gate Voltage Drain Current | | $V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$ | | | 10 | μΑ |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 10$ V, $V_{GS} = 10$ V | 30 | | | Α |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ | | 0.0103 | 0.0125 | Ω |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 10 A | | 18 | | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | | | 2840 | | pF |
| Output Capacitance | C _{oss} | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 325 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 120 | | |
| Total Gate Charge | Qg | | | 46 | 70 | nC |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 40$ V, $V_{GS} = 10$ V, $I_{D} = 10$ A | | 15 | | |
| Gate-Drain Charge | Q _{gd} | | | 13 | | |
| Gate Resistance | Rg | f = 1 MHz | | 0.8 | 1.6 | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 18 | 35 | ns |
| Rise Time | t _r | V_{DD} = 40 V, R_L = 4 Ω | | 10 | 20 | |
| Turn-Off Delay Time | t _{d(off)} | $\text{I}_\text{D}\cong$ 10 A, V_GEN = 10 V, R_g = 1 Ω | | 24 | 45 | |
| Fall Time | t _f | | | 8 | 16 | |
| Turn-On Delay Time | t _{d(on)} | | | 25 | 50 | ns |
| Rise Time | t _r | V_{DD} = 40 V, R_L = 4 Ω | | 11 | 22 | - |
| Turn-Off Delay Time | t _{d(off)} | $\text{I}_\text{D}\cong$ 10 A, V_GEN = 10 V, R_g = 6 Ω | | 32 | 60 | |
| Fall Time | t _f | | | 10 | 20 | |
| Drain-Source Body Diode Characteristi | cs | | | | | |
| Continuous Source-Drain Diode Current | ۱ _S | T _C = 25 °C | | | 32 | ^ |
| Pulse Diode Forward Current ^a | I _{SM} | | | | 60 | A |
| Body Diode Voltage | V _{SD} | I _S = 4.9 A | | 0.78 | 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | 58 | 90 | ns |
| Body Diode Reverse Recovery Charge Q _{rr} | | $L = 10.0 \text{ d}/\text{d}t = 100.04/\text{s}_{2}$ T = 25.00 | | 145 | 230 | nC |
| Reverse Recovery Fall Time | t _a | - I _F = 10 A, dl/dt = 100 A/μs, T _J = 25 °C - | | 43 | | |
| Reverse Recovery Rise Time | t _b | 1 | | 15 | | ns |

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

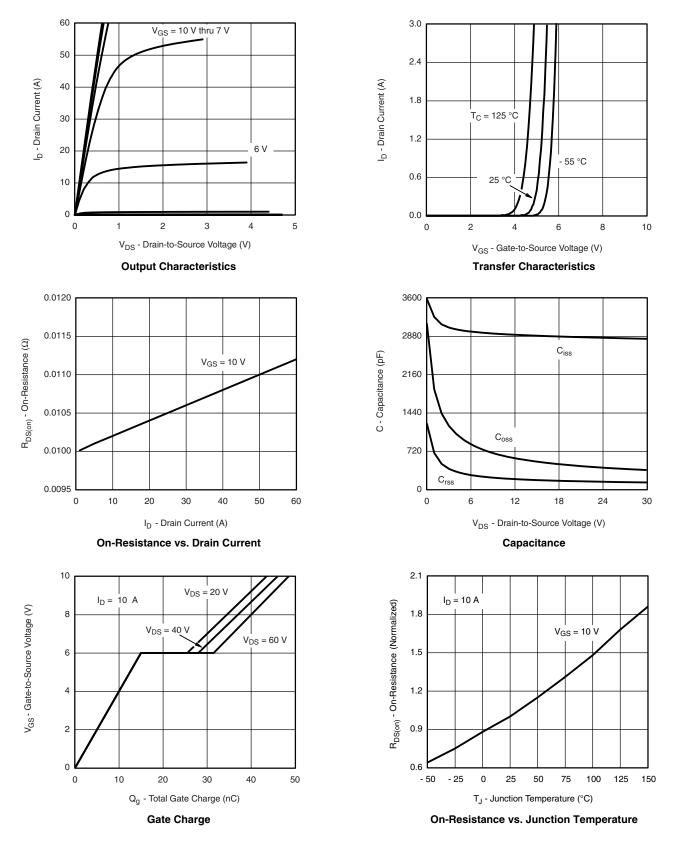
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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Si7186DP Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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For technical questions, contact: pmostechsupport@vishay.com

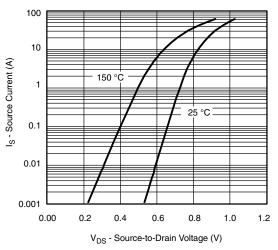
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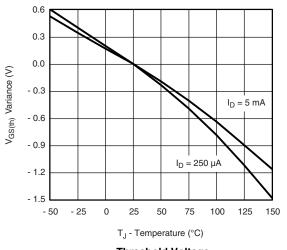
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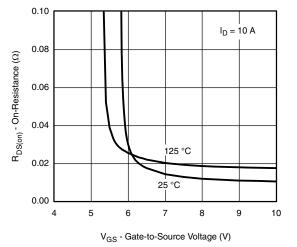
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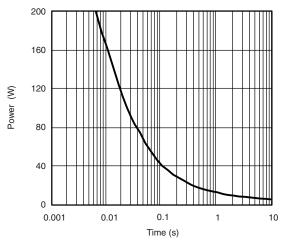
Source-Drain Diode Forward Voltage



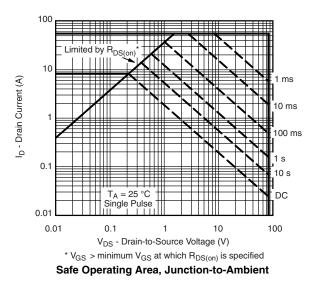




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

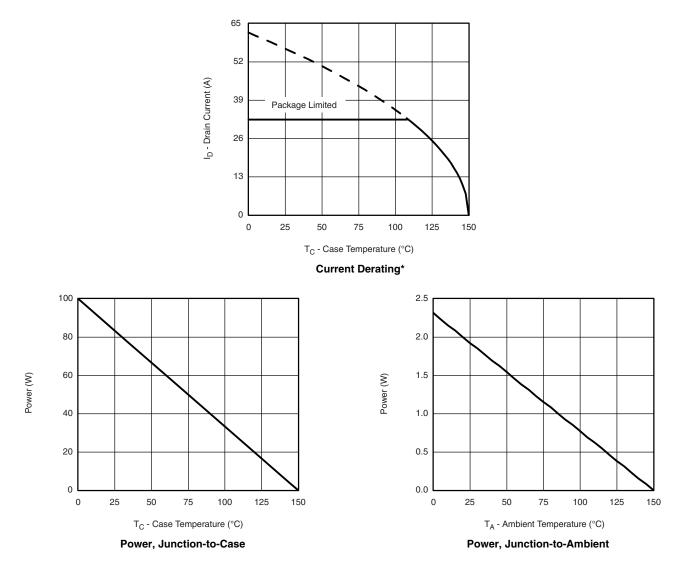


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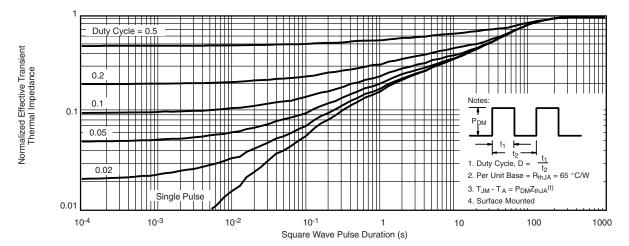
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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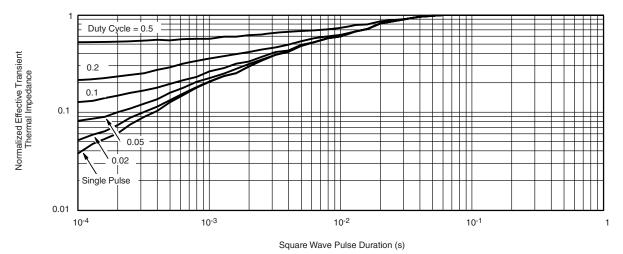


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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